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MPSH11

MMBTH11





NPN RF Transistor

This device is designed for common-emitter low noise amplifier and mixer applications with collector currents in the 100 μA to 10 mA range to 300 MHz, and low frequency drift commonbase VHF oscillator applications with high output levels for driving FET mixers. Sourced from Process 47.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	25	V
V _{CBO}	Collector-Base Voltage	30	V
V _{EBO}	Emitter-Base Voltage	3.0	V
I _C	Collector Current - Continuous	50	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.

 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units	
		MPSH11	*MMBTH11		
P_{D}	Total Device Dissipation	350	225	mW	
	Derate above 25°C	2.8	1.8	mW/°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125		°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	556	°C/W	

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

(continued)

	Electri	cal Cl	harac	teri	stic
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TA = 25°C unless otherwise noted

Parameter	Test Conditions	Min	Max	Units
RACTERISTICS				
Collector-Emitter Sustaining Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	25		V
Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	30		V
Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	3.0		V
Collector Cutoff Current	$V_{CB} = 25 \text{ V}, I_{E} = 0$		100	nA
Emitter Cutoff Current	$V_{EB} = 2.0 \text{ V}, I_{C} = 0$		100	nA
	RACTERISTICS Collector-Emitter Sustaining Voltage* Collector-Base Breakdown Voltage Emitter-Base Breakdown Voltage Collector Cutoff Current			$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

ON CHARACTERISTICS

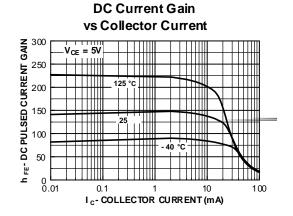
h _{FE}	DC Current Gain	$I_C = 4.0 \text{ mA}, V_{CE} = 10 \text{ V}$	60		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 4.0 \text{ mA}, I_B = 0.4 \text{ mA}$		0.5	V
V _{BE(on)}	Base-Emitter On Voltage	$I_C = 4.0 \text{ mA}, V_{CE} = 10 \text{ V}$		0.95	V

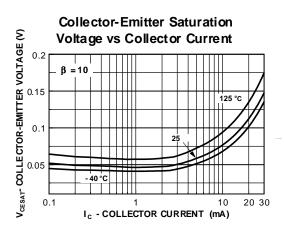
SMALL SIGNAL CHARACTERISTICS

f _T	Current Gain - Bandwidth Product	$I_C = 4.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 100 MHz	650		MHz
C _{cb}	Collector-Base Capacitance	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1.0 \text{ MHz}$		0.7	pF
C _{rb}	Common-Base Feedback Capacitance	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1.0 \text{ MHz}$	0.6	0.9	pF
rb묬 _c	Collector Base Time Constant	$I_C = 4.0 \text{ mA}, V_{CB} = 10 \text{ V},$ f = 31.8 MHz		9.0	pS

^{*}Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%

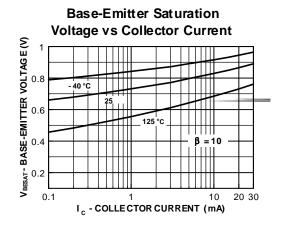
Typical Characteristics

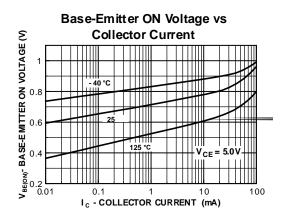




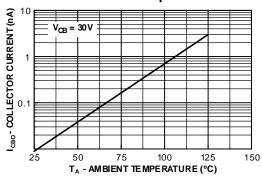
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Typical Characteristics (continued)

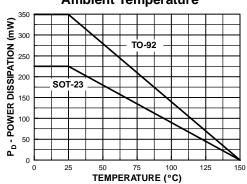




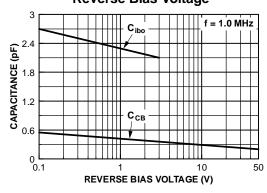
Collector Cut-Off Current vs Ambient Temperature



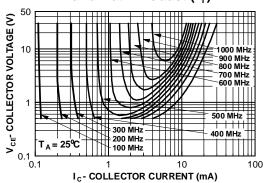




Capacitance vs Reverse Bias Voltage



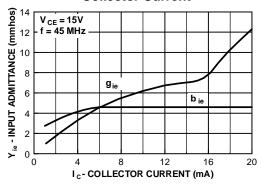
Contours of Constant Gain Bandwidth Product (f_T)



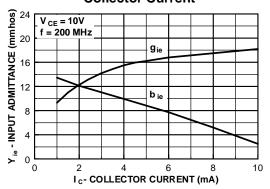
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Common Emitter Y Parameters

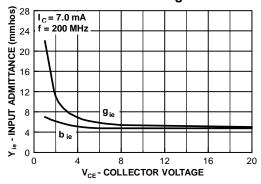




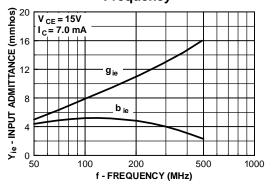
Input Admittance vs Collector Current



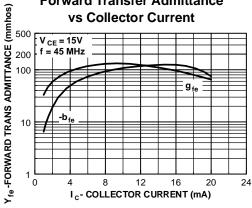
Input Admittance vs Collector Voltage



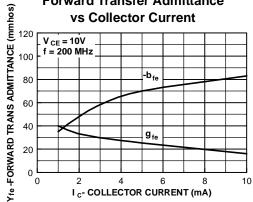
Input Admittance vs Frequency



Forward Transfer Admittance

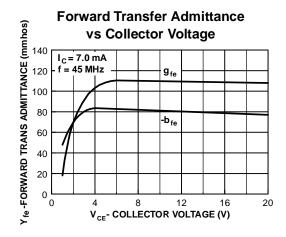


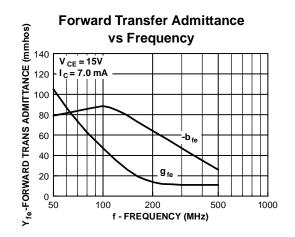
Forward Transfer Admittance

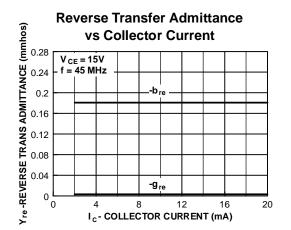


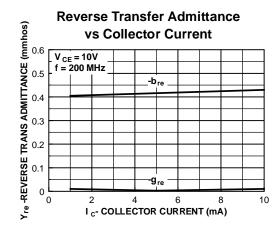
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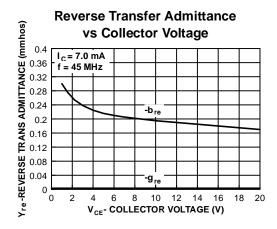
Common Emitter Y Parameters (continued)

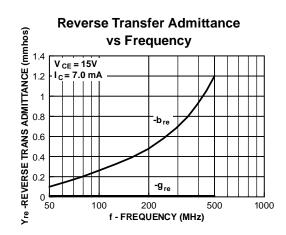








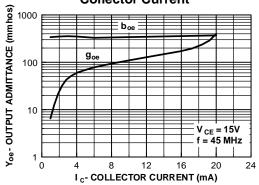




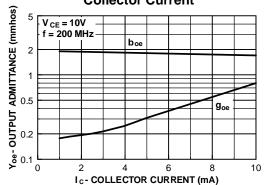
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Common Emitter Y Parameters (continued)

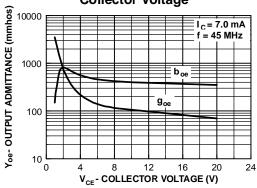




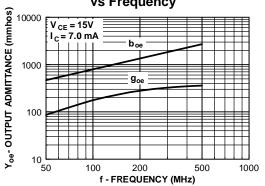
Output Admittance vs Collector Current



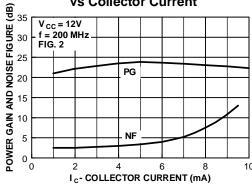
Output Admittance vs Collector Voltage



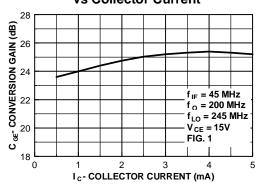
Output Admittance vs Frequency



Power Gain and Noise Figure vs Collector Current



Conversion Gain vs Collector Current



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Test Circuits

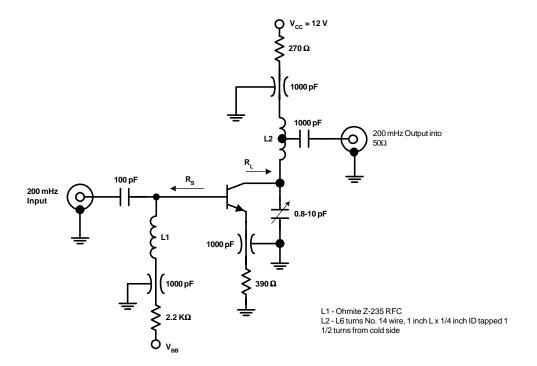


FIGURE 1: Unneutralized 200 MHz PG and NF Test Circuit

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Test Circuits (continued)

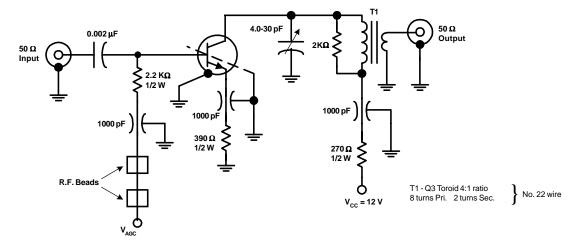


FIGURE 2: 45 MHz Power Gain Circuit

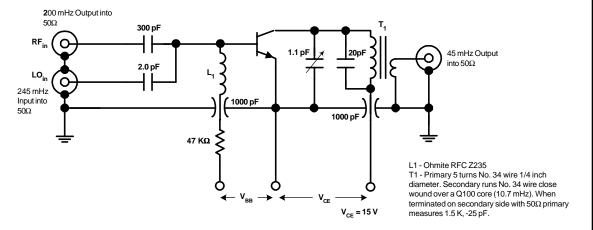


FIGURE 3: 200 MHz Conversion Gain Test Circuit

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